特力材料886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

# **SN54ACT573, SN74ACT573** OCTAL D-TYPE TRANSPARENT LATCHES

OCTOBER 1995 - REVISED OCTOBER 2

- 4.5-V to 5.5-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 5.5 V
- Max tod of 9.5 ns at 5 V
- Inputs Are TTL-Voltage Compatible

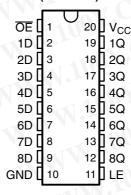
#### description/ordering information

These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. The devices are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

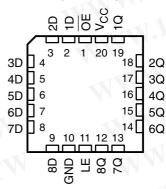
The eight latches are D-type transparent latches. When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the logic levels set up at the D inputs.

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines in a bus-organized system without need for interface or pullup components.

SN54ACT573 . . . J OR W PACKAGE SN74ACT573...DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



#### SN54ACT573...FK PACKAGE (TOP VIEW)



OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, OE should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### ORDERING INFORMATION

TA	PACK	AGE <sup>†</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
1. 1	PDIP – N	Tube	SN74ACT573N	SN74ACT573N
	0010 PW	Tube	SN74ACT573DW	AOT570
10001 0500	SOIC - DW	Tape and reel	SN74ACT573DWR	ACT573
-40°C to 85°C	SOP – NS	Tape and reel	SN74ACT573NSR	ACT573
	SSOP – DB	Tape and reel	SN74ACT573DBR	AD573
ON	TSSOP - PW	Tape and reel	SN74ACT573PWR	AD573
	CDIP – J	Tube	SNJ54ACT573J	SNJ54ACT573J
-55°C to 125°C	CFP – W	Tube	SNJ54ACT573W	SNJ54ACT573W
	LCCC - FK	Tube	SNJ54ACT573FK	SNJ54ACT573FK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



### SN54ACT573, SN74ACT573 OCTAL D-TYPE TRANSPARENT LATCHES WITH 3-STATE OUTPUTS

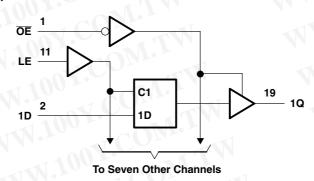
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# FUNCTION TABLE (each latch)

	INPUTS		OUTPUT
OE	LE	D	Q
L	Н	Н	Н
T.	Н	L	L
L	L	X	$Q_0$
CH	Χ	X	Z

#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>		–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)		
Output voltage range, V <sub>O</sub> (see Note 1)		. $-0.5$ V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )		±20 mA
Output clamp current, IOK (VO < 0 or VO > VCC)	)	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	4	±50 mA
Continuous current through, V <sub>CC</sub> or GND		±200 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2):	: DB package	70°C/W
	DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
	PW package	83°C/W
Storage temperature range, T <sub>stq</sub>		65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



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#### recommended operating conditions (see Note 3)

	1001	SN54A	CT573	SN74A	CT573	<b>—</b>
		MIN	MAX	MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage	2	0	2	O.	٧
$V_{IL}$	Low-level input voltage	_ 1	0.8	7.	8.0	V
VI	Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
Vo	Output voltage	0	V <sub>CC</sub>	0	$V_{CC}$	V
I <sub>OH</sub>	High-level output current		-24		-24	mA
I <sub>OL</sub>	Low-level output current		24	$UD_{-1}$	24	mA
Δt/Δν	Input transition rise or fall rate		8		8	ns/V
T <sub>A</sub>	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

-s1	7	Dr.	Ţ	A = 25°C	;	SN54A	CT573	SN74A	CT573	
PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
- 1		4.5 V	4.4	4.49		4.4	411	4.4		
	$I_{OH} = -50 \mu\text{A}$	5.5 V	5.4	5.49		5.4		5.4	d 11	
	04 m4	4.5 V	3.86		1	3.7	- 4	3.76	4.0-	- 0
V <sub>OH</sub>	I <sub>OH</sub> = - 24 mA	5.5 V	4.86			4.7		4.76	_111	A
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V	$O_{I_{A}}$		XXI	3.85				
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V						3.85		
71		4.5 V		1	0.1		0.1	-31	0.1	
	$I_{OL} = 50 \mu A$	5.5 V		11	0.1		0.1		0.1	
	11 04 mA	4.5 V		N.	0.36	(1	0.44	_ <	0.44	N
V <sub>OL</sub>	I <sub>OL</sub> = 24 mA	5.5 V			0.36		0.44		0.44	V
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V	-7 (	$O_{N}$	1.0	- 1	1.65		- T	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V	1						1.65	
l <sub>OZ</sub>	$V_O = V_{CC}$ or GND	5.5 V	_7	C(0)	±0.25	_ 1	±5		±2.5	μΑ
T <sub>1</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V			±0.1		±1		±1	μА
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V		. ~(	4		80		40	μΑ
Δl <sub>CC</sub> ‡	One input at 3.4 V, Other inputs at GND or V <sub>CC</sub>	5.5 V	007	0.6			1.5		1.5	mA
Ci	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V	00	5		- 11			4	pF

<sup>&</sup>lt;sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

Ta	COMM	$T_A = 2$	25°C	SN54A	CT573	SN74A	CT573	
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t <sub>w</sub>	Pulse duration, LE high	3.5		5	1	4		ns
t <sub>su</sub>	Setup time, data before LE↓	3		4.5		3.5		ns
t <sub>h</sub>	Hold time, data after LE↓	0		_1	MAT	0	- 1	ns

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<sup>&</sup>lt;sup>‡</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V<sub>CC</sub>.

# **SN54ACT573, SN74ACT573** OCTAL D-TYPE TRANSPARENT LATCHES

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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

24244	FROM	ТО	T	<sub>A</sub> = 25°C		SN54A	CT573	SN74A	CT573	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
t <sub>PLH</sub>		COM.	2.5	6	10.5	1.5	13.5	2	12	771
t <sub>PHL</sub>	D	Q	2.5	6	10.5	1.5	13.5	2	12	ns
t <sub>PLH</sub>			3	6	10.5	1.5	13	2.5	12	Ob
t <sub>PHL</sub>	LE	Q	2.5	5.5	9.5	1.5	12	2	10.5	ns
t <sub>PZH</sub>		(0)	2	5.5	10	1.5	11.5	1.5	11	$\cap(0)$
t <sub>PZL</sub>	OE	Q	1.5	5.5	9.5	1.5	11	1.5	10.5	ns
t <sub>PHZ</sub>	ŌĒ		2.5	6.5	11	1.5	13.5	1.5	12.5	, c(
t <sub>PLZ</sub>	OE .	QUA	1.5	5	8.5	1.5	10.5	1	9.5	ns

### operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub> Power dissipation capacitance	$C_L = 50 \text{ pF},  f = 1 \text{ MHz}$	25	pF

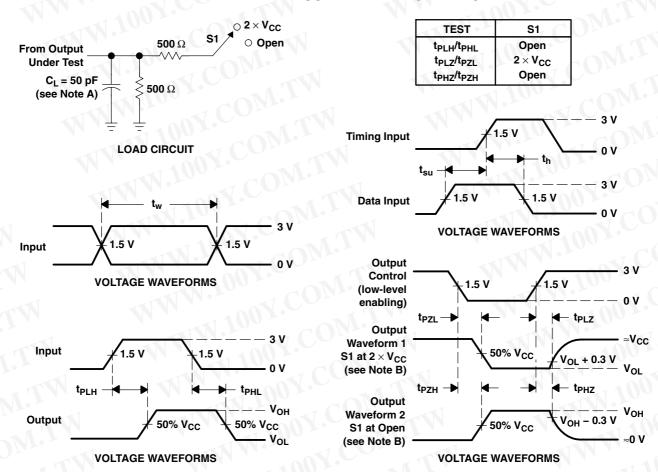
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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





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### **PACKAGE OPTION ADDENDUM**

24-Jan-2013

### **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings (4)
5962-87664012A	ACTIVE	LCCC	FK	20	100 Y.C	TBD	Call TI	Call TI	-55 to 125	5962- 87664012A SNJ54ACT 573FK
5962-8766401RA	ACTIVE	CDIP	J	20	N.190	TBD	Call TI	Call TI	-55 to 125	5962-8766401RA SNJ54ACT573J
5962-8766401SA	ACTIVE	CFP	W	20	1100	TBD	Call TI	Call TI	-55 to 125	5962-8766401SA SNJ54ACT573W
SN74ACT573DBLE	OBSOLETE	SSOP	DB	20	-TXV 100	TBD	Call TI	Call TI	-40 to 85	D.M.
SN74ACT573DBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SN74ACT573DBRE4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SN74ACT573DBRG4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SN74ACT573DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT573
SN74ACT573DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT573
SN74ACT573DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT573
SN74ACT573DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT573
SN74ACT573N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-40 to 85	SN74ACT573N
SN74ACT573NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-40 to 85	SN74ACT573N
SN74ACT573NSR	ACTIVE	so /	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT573
SN74ACT573NSRE4	ACTIVE	so .	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT573
SN74ACT573NSRG4	ACTIVE	so	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT573



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### PACKAGE OPTION ADDENDUM

24-Jan-2013

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings (4)
SN74ACT573PW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SN74ACT573PWE4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SN74ACT573PWG4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SN74ACT573PWLE	OBSOLETE	TSSOP	PW	20	N.Iu	TBD	Call TI	Call TI	-40 to 85	
SN74ACT573PWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SN74ACT573PWRE4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SN74ACT573PWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD573
SNJ54ACT573FK	ACTIVE	LCCC	FK	20	WWW.1	TBD	POST-PLATE	N / A for Pkg Type		5962- 87664012A SNJ54ACT 573FK
SNJ54ACT573J	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8766401RA SNJ54ACT573J
SNJ54ACT573W	ACTIVE	CFP	W	20	M.	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8766401SA SNJ54ACT573W

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)



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### PACKAGE OPTION ADDENDUM

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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#### OTHER QUALIFIED VERSIONS OF SN54ACT573, SN74ACT573:

Catalog: SN74ACT573

Military: SN54ACT573

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



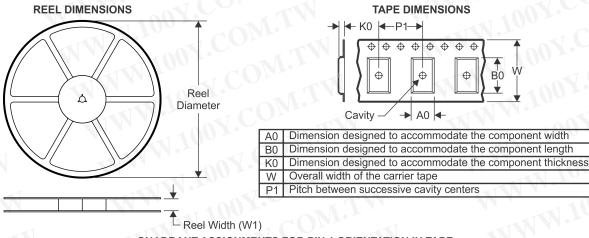
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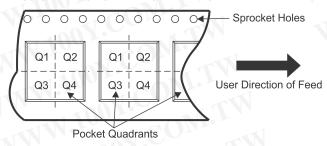
### PACKAGE MATERIALS INFORMATION

26-Jan-2013

#### TAPE AND REEL INFORMATION



#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

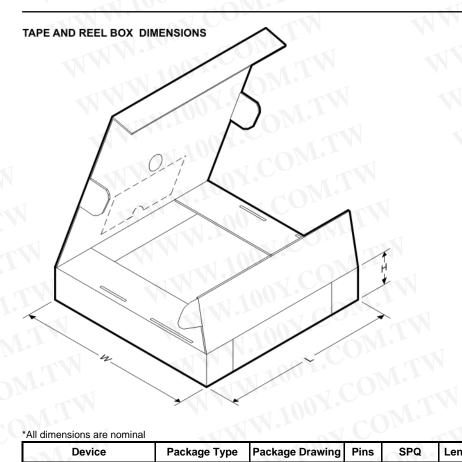


#### \*All dimensions are nominal

di dimensions are nomina	l		-1								-	
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ACT573DBR	SSOP	DB	20	2000	330.0	16.4	8.2	7.5	2.5	12.0	16.0	Q1
SN74ACT573DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.0	2.7	12.0	24.0	Q1
SN74ACT573NSR	SO	NS <	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1
SN74ACT573PWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1

### PACKAGE MATERIALS INFORMATION

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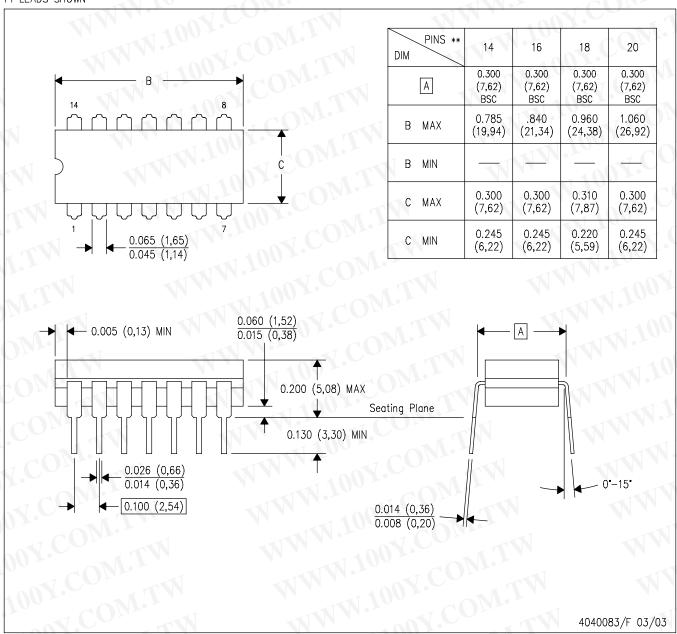
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SN74ACT573DBR SSOP DB 20 2000 367.0 367.0 38.0
CN74A CTE77DIVID COIC DW 20 2000 207 0 207 0 45 0
SN74ACT573DWR SOIC DW 20 2000 367.0 367.0 45.0
SN74ACT573NSR SO NS 20 2000 367.0 367.0 45.0
SN74ACT573PWR TSSOP PW 20 2000 367.0 367.0 38.0

#### 14 LEADS SHOWN

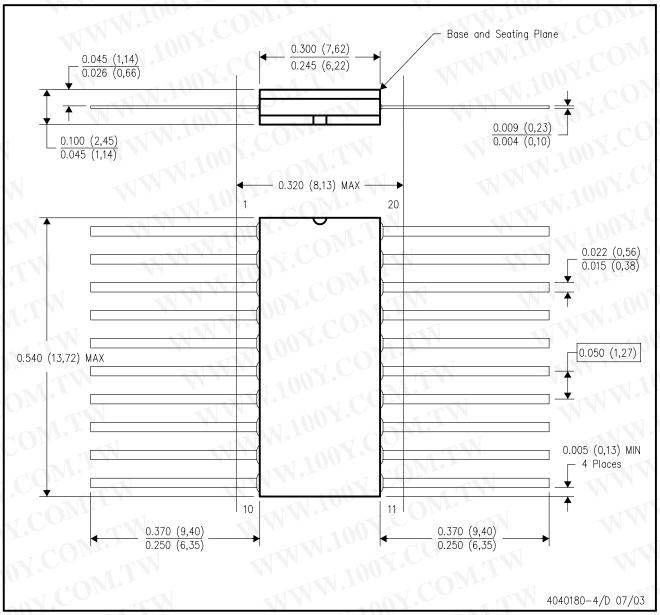


NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F20)

### CERAMIC DUAL FLATPACK



NOTES:

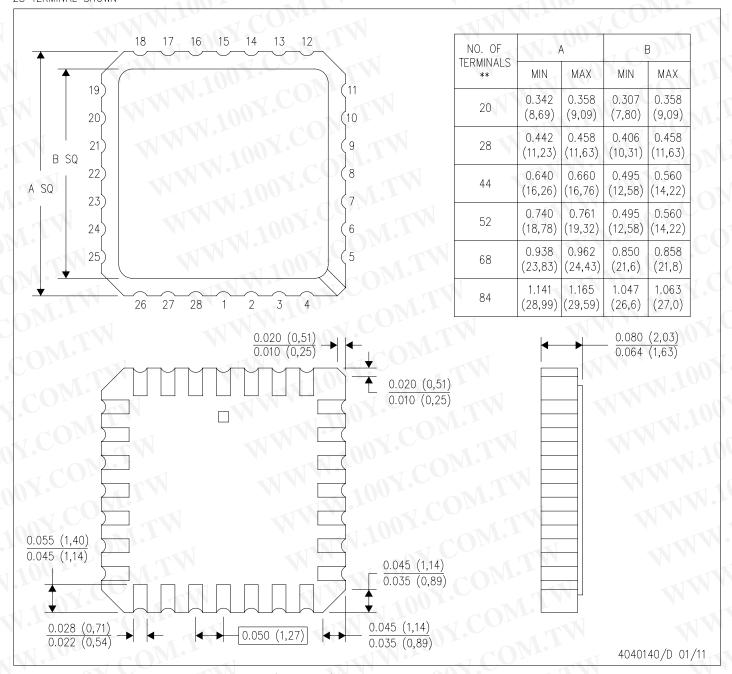
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



## FK (S-CQCC-N\*\*)

### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES:

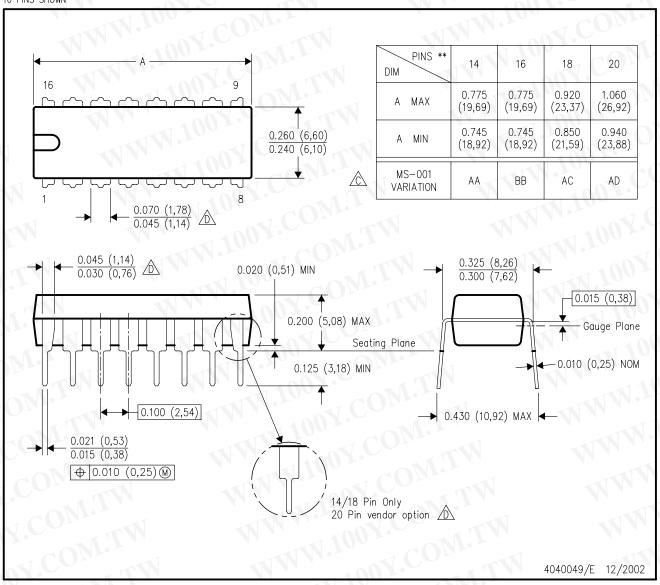
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- ∕C Falls within JEDEC MS—001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

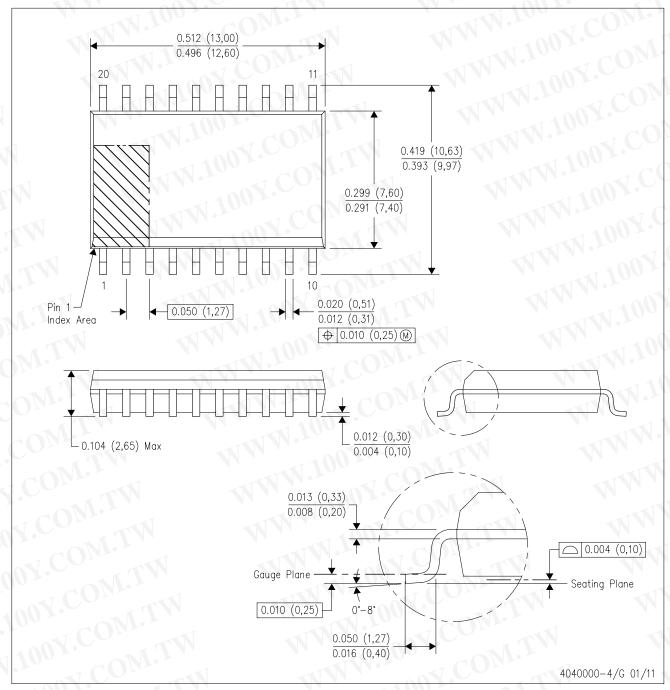


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DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



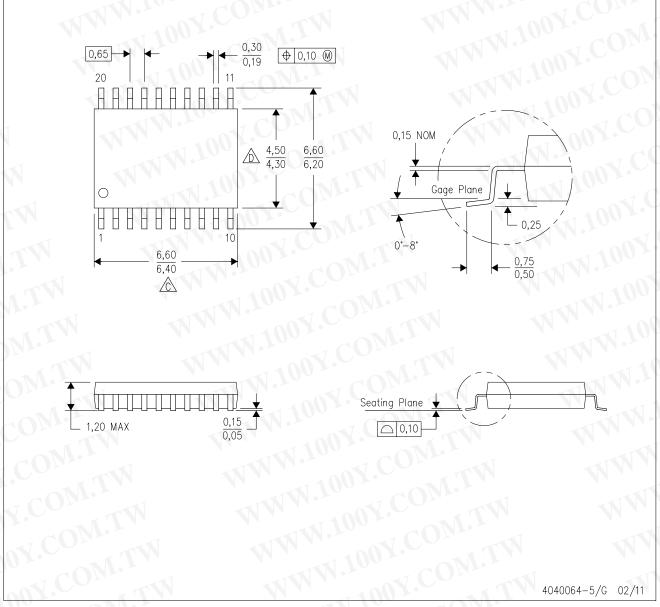
NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M—1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



PW (R-PDSO-G20)

### PLASTIC SMALL OUTLINE



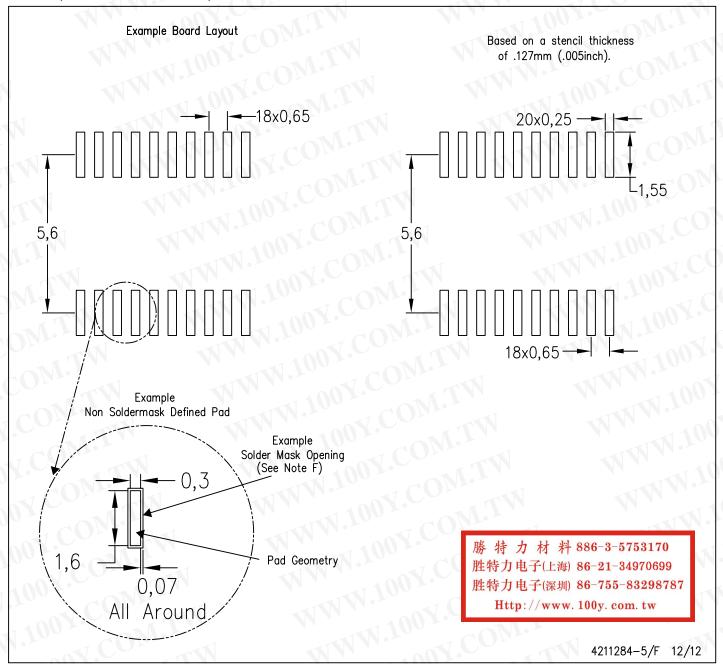
NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
- Sody length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- 🖄 Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



## PW (R-PDSO-G20)

### PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

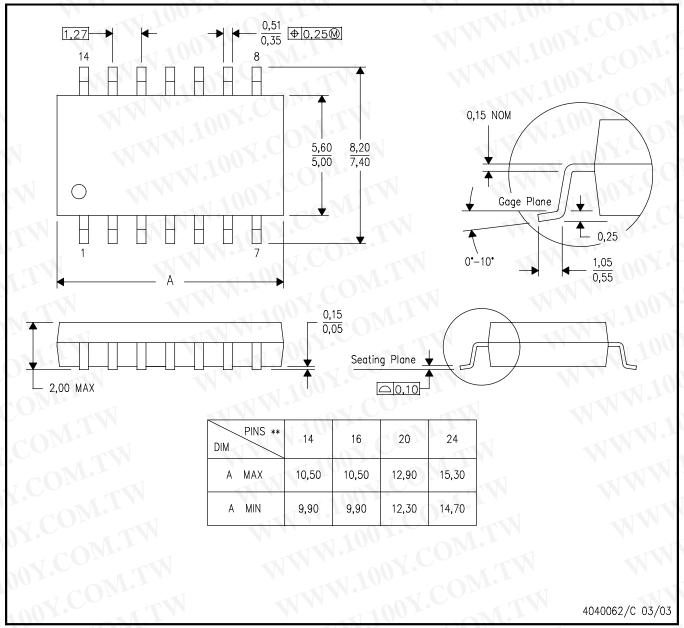


#### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

### 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

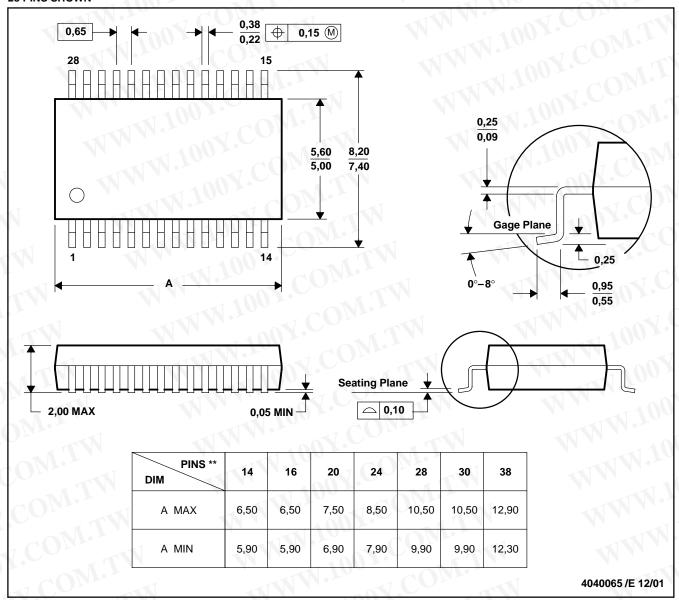
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



#### DB (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150



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